



Vincotech

10-EY12NMA011ME30-LS28F18T

datasheet

flowMNPC E2

1200 V / 11 mΩ

Topology features

- Kelvin Emitter for improved switching performance
- Temperature sensor
- Mixed Voltage Neutral Point Clamped Topology (T-Type)

Component features

- High Blocking Voltage with low drain source on state resistance
- High speed SiC-MOSFET technology
- Resistant to Latch-up

Housing features

- Base isolation: Al₂O₃
- Convex shaped substrate for superior thermal contact
- Compact housing
- CTI600 housing material
- Thermo-mechanical push-and-pull force relief
- Press-fit pin
- Reliable cold welding connection

Extra features

- full 1200V SiCMOS
- Equivalent F3L11MR12W2M1HP_B19

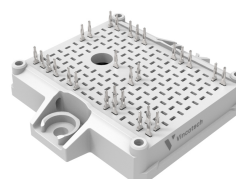
Target applications

- Power Supply

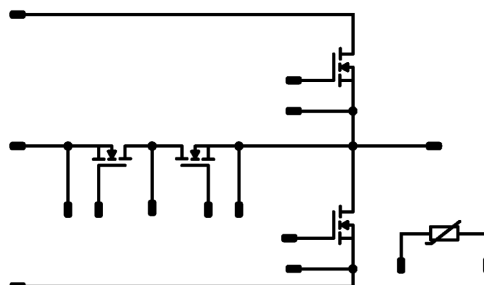
Types

- 10-EY12NMA011ME30-LS28F18T

flow E2 12 mm housing



Schematic





Vincotech

10-EY12NMA011ME30-LS28F18T
datasheet

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Buck Switch				
Drain-source voltage	V_{DS}		1200	V
Drain current (DC current)	I_D	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	110	A
Peak drain current	I_{DM}	t_p limited by T_{jmax}	360	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	194	W
Gate-source voltage	V_{GS}	static	-4 / 15	V
		dynamic	-8 / 19	V
Maximum Junction Temperature	T_{jmax}		175	°C

Boost Switch

Drain-source voltage	V_{DS}		1200	V
Drain current (DC current)	I_D	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	110	A
Peak drain current	I_{DM}	t_p limited by T_{jmax}	360	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	194	W
Gate-source voltage	V_{GS}	static	-4 / 15	V
		dynamic	-8 / 19	V
Maximum Junction Temperature	T_{jmax}		175	°C

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
Creepage distance			>12,7	mm
Clearance			9,08	mm
Comparative Tracking Index	CTI		≥ 600	

*100 % tested in production



Vincotech

10-EY12NMA011ME30-LS28F18T
datasheet

Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Buck Switch

Static

Drain-source on-state resistance	$r_{DS(on)}$		15		120	25 125 150	7,47	10,4 13,8 15,4	13,9 ⁽¹⁾	mΩ
Gate-source threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$			0,0345	25	1,8	2,5	3,6	V
Gate to Source Leakage Current	I_{GSS}		15	0		25		30	750	nA
Zero Gate Voltage Drain Current	I_{DSS}		0	1200		25		3	57	μA
Internal gate resistance	r_g							0,567		Ω
Gate charge	Q_g		-4/15	800	120	25		354		nC
Short-circuit input capacitance	C_{iss}	$f = 100 \text{ kHz}$	0	1000	0	25		10071		pF
Short-circuit output capacitance	C_{oss}							387		
Reverse transfer capacitance	C_{rss}							24		
Diode forward voltage	V_{SD}		0		60	25		4,6		V

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{\text{paste}} = 3,4 \text{ W/mK}$ (PSX)						0,49		K/W
--	---------------	--	--	--	--	--	--	------	--	-----



Vincotech

10-EY12NMA011ME30-LS28F18T

datasheet

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit	
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		
Dynamic											
Turn-on delay time	$t_{d(on)}$	$R_{gon} = 4 \ \Omega$ $R_{goff} = 4 \ \Omega$	-4/15	350	95	25		39,73		ns	
						125		36,37			
						150		35,82			
Rise time	t_r					25		19,2		ns	
						125		16,47			
						150		15,97			
Turn-off delay time	$t_{d(off)}$					25		78,17		ns	
						125		85,41			
						150		87,88			
Fall time	t_f					25		26,82		ns	
						125		26,52			
						150		27,83			
Turn-on energy (per pulse)	E_{on}	Q_{tFWD} =0,834 μ C Q_{tFWD} =1,74 μ C Q_{tFWD} =2,05 μ C	25		0,572		mWs				
			125		0,522						
			150		0,512						
Turn-off energy (per pulse)	E_{off}		25		0,359		mWs				
			125		0,372						
			150		0,38						
Peak recovery current	I_{RRM}	di/dt =6062 A/ μ s di/dt =6980 A/ μ s di/dt =6940 A/ μ s	25		60,77		A				
			125		93,48						
			150		103,96						
Reverse recovery time	t_{rr}		25		23,51		ns				
			125		30,2						
			150		32,02						
Recovered charge	Q_r		25		0,834		μ C				
			125		1,74						
			150		2,05						
Reverse recovered energy	E_{rec}		25		0,172		mWs				
			125		0,428						
			150		0,511						
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		25		7756,34		A/ μ s				
			125		8647,86						
			150		9554,37						



Vincotech

10-EY12NMA011ME30-LS28F18T
datasheet

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Boost Switch

Static

Drain-source on-state resistance	$r_{DS(on)}$		15		120	25 125 150	7,47	10,4 13,8 15,4	13,9 ⁽¹⁾	mΩ
Gate-source threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$			0,0345	25	1,8	2,5	3,6	V
Gate to Source Leakage Current	I_{GSS}		15	0		25		30	750	nA
Zero Gate Voltage Drain Current	I_{DSS}		0	1200		25		3	57	μA
Internal gate resistance	r_g							0,567		Ω
Gate charge	Q_g		-4/15	800	120	25		354		nC
Short-circuit input capacitance	C_{iss}	$f = 100 \text{ kHz}$	0	1000	0	25		10071		pF
Short-circuit output capacitance	C_{oss}							387		
Reverse transfer capacitance	C_{rss}							24		
Diode forward voltage	V_{SD}		0		60	25		4,6		V

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{\text{paste}} = 3,4 \text{ W/mK}$ (PSX)						0,49		K/W
--	---------------	--	--	--	--	--	--	------	--	-----



Vincotech

10-EY12NMA011ME30-LS28F18T

datasheet

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit	
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		
Dynamic											
Turn-on delay time	$t_{d(on)}$	$R_{gon} = 4 \ \Omega$ $R_{goff} = 4 \ \Omega$	-4/15	350	80	25		35,62		ns	
						125		32,07			
						150		31,59			
Rise time	t_r					25		17,8			ns
						125		15,82			
						150		15,53			
Turn-off delay time	$t_{d(off)}$					25		84,58			ns
						125		93,14			
						150		95,5			
Fall time	t_f					25		33,05			ns
						125		33,75			
						150		32,97			
Turn-on energy (per pulse)	E_{on}	$Q_{tFWD}=1,06 \ \mu C$ $Q_{tFWD}=1,88 \ \mu C$ $Q_{tFWD}=2,17 \ \mu C$	25		0,475			mWs			
			125		0,401						
			150		0,392						
Turn-off energy (per pulse)	E_{off}		25		0,292			mWs			
			125		0,305						
			150		0,311						
Peak recovery current	I_{RRM}	$di/dt=5304 \ A/\mu s$ $di/dt=6397 \ A/\mu s$ $di/dt=6466 \ A/\mu s$	25		75,78			A			
			125		104,36						
			150		112,08						
Reverse recovery time	t_{rr}		25		23,88			ns			
			125		29,41						
			150		31,25						
Recovered charge	Q_r		25		1,06			μC			
			125		1,88						
			150		2,17						
Reverse recovered energy	E_{rec}		25		0,247			mWs			
			125		0,476						
			150		0,554						
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$	25		11736,21			A/ μs				
		125		11655,54							
		150		11052,36							



Vincotech

10-EY12NMA011ME30-LS28F18T
datasheet

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Thermistor

Static

Rated resistance	R					25		5		k Ω
Deviation of R100	$\Delta_{R/R}$	$R_{100} = 493 \Omega$				100	-5		5	%
Power dissipation	P							245		mW
Power dissipation constant	d					25		1,4		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 2 \%$						3375		K
B-value	$B_{(25/100)}$	Tol. $\pm 2 \%$						3437		K
Vincotech Thermistor Reference									K	

⁽¹⁾ Value at chip level

⁽²⁾ Only valid with pre-applied Vincotech thermal interface material.



Vincotech

10-EY12NMA011ME30-LS28F18T

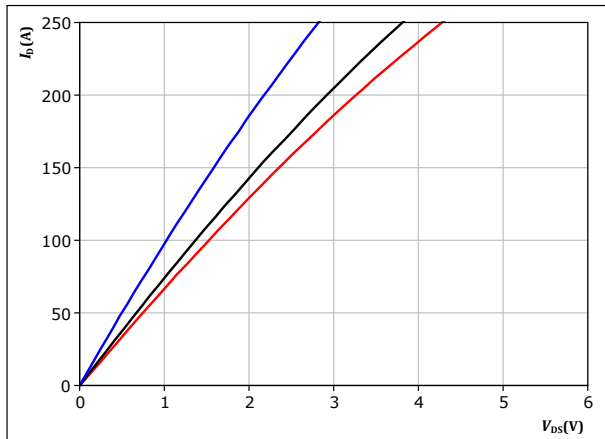
datasheet

Buck Switch Characteristics

figure 1. MOSFET

Typical output characteristics

$$I_D = f(V_{DS})$$

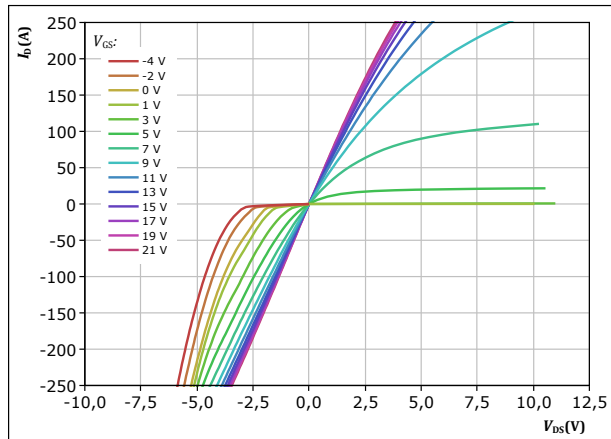


$t_p = 250 \mu s$
 $V_{GS} = 15 V$
 $T_j: 25 ^\circ C$
 $125 ^\circ C$
 $150 ^\circ C$

figure 2. MOSFET

Typical output characteristics

$$I_D = f(V_{DS})$$

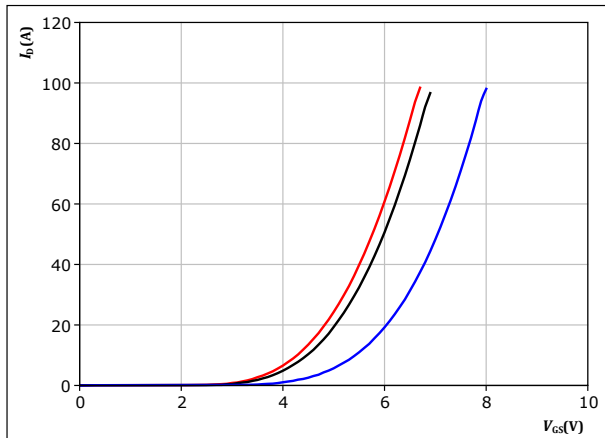


$t_p = 250 \mu s$
 $T_j = 150 ^\circ C$
 V_{GS} from -4 V to 21 V in steps of 2 V

figure 3. MOSFET

Typical transfer characteristics

$$I_D = f(V_{GS})$$

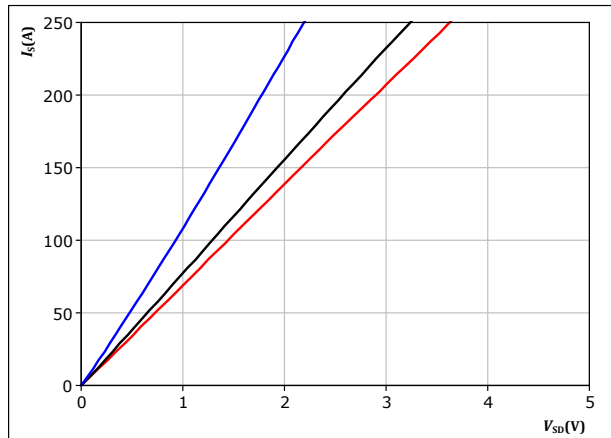


$t_p = 250 \mu s$
 $V_{DS} = 10 V$
 $T_j: 25 ^\circ C$
 $125 ^\circ C$
 $150 ^\circ C$

figure 4. MOSFET

Typical reverse drain current characteristics

$$I_{SD} = f(V_{SD})$$



$t_p = 250 \mu s$
 $V_{GS} = 15 V$
 $T_j: 25 ^\circ C$
 $125 ^\circ C$
 $150 ^\circ C$



Vincotech

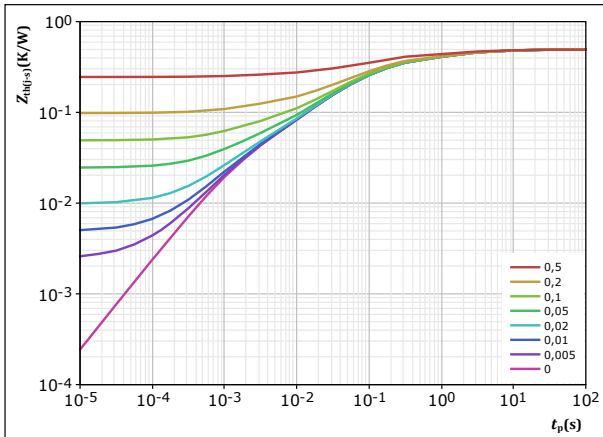
Buck Switch Characteristics

figure 5.

MOSFET

Transient thermal impedance as a function of pulse width

$$Z_{th(j-a)} = f(t_p)$$



$$D = \frac{t_p}{T}$$

$$R_{th(j-a)} = 0,491 \text{ K/W}$$

MOSFET thermal model values

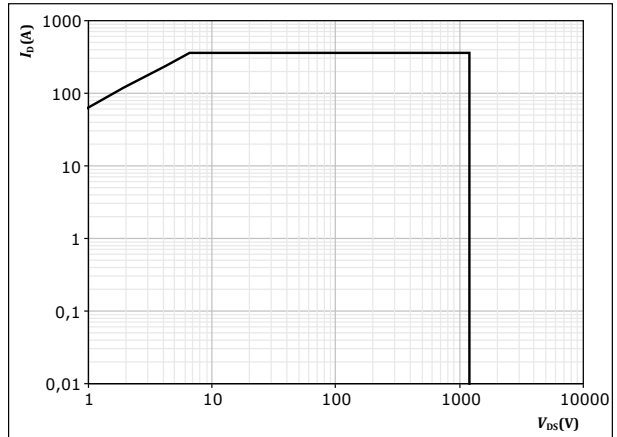
R (K/W)	τ (s)
4,84E-02	6,00E+00
1,15E-01	9,56E-01
2,27E-01	9,87E-02
7,54E-02	1,62E-02
2,51E-02	1,45E-03

figure 6.

MOSFET

Safe operating area

$$I_D = f(V_{DS})$$



D = single pulse

$$T_a = 80 \text{ } ^\circ\text{C}$$

$$V_{GS} = 15 \text{ V}$$

$$T_j = T_{jmax}$$



Vincotech

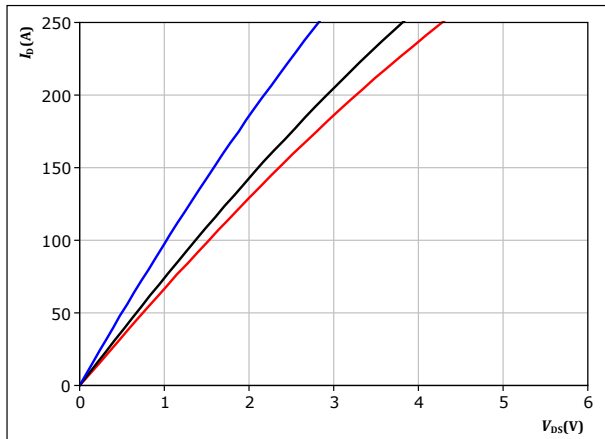
10-EY12NMA011ME30-LS28F18T datasheet

Boost Switch Characteristics

figure 7. MOSFET

Typical output characteristics

$$I_D = f(V_{DS})$$

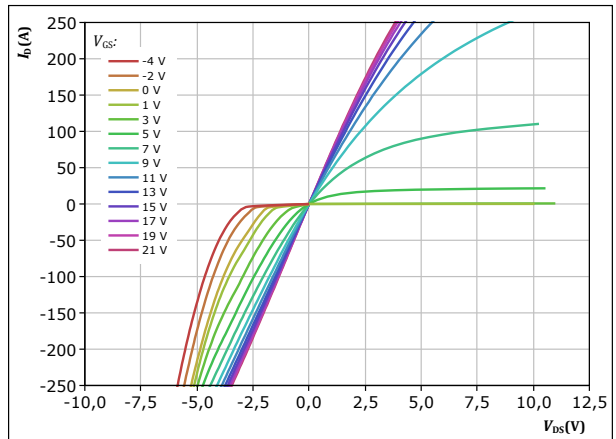


$t_p = 250 \mu s$
 $V_{GS} = 15 V$
 $T_j: 25^\circ C, 125^\circ C, 150^\circ C$

figure 8. MOSFET

Typical output characteristics

$$I_D = f(V_{DS})$$

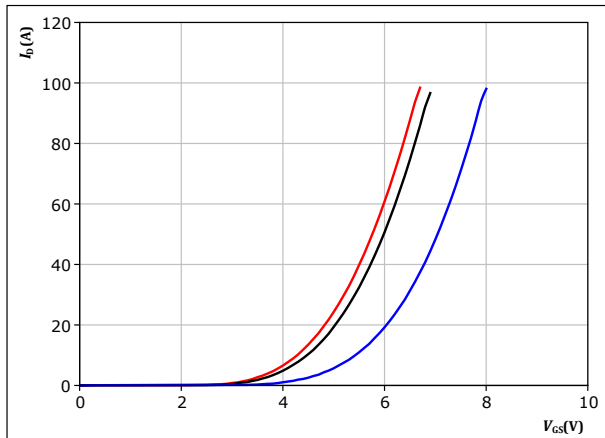


$t_p = 250 \mu s$
 $T_j = 150^\circ C$
 V_{GS} from -4 V to 21 V in steps of 2 V

figure 9. MOSFET

Typical transfer characteristics

$$I_D = f(V_{GS})$$

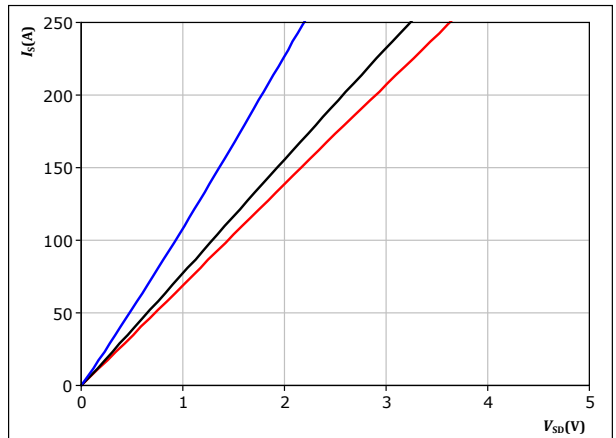


$t_p = 250 \mu s$
 $V_{DS} = 10 V$
 $T_j: 25^\circ C, 125^\circ C, 150^\circ C$

figure 10. MOSFET

Typical reverse drain current characteristics

$$I_{SD} = f(V_{SD})$$



$t_p = 250 \mu s$
 $V_{GS} = 15 V$
 $T_j: 25^\circ C, 125^\circ C, 150^\circ C$



Vincotech

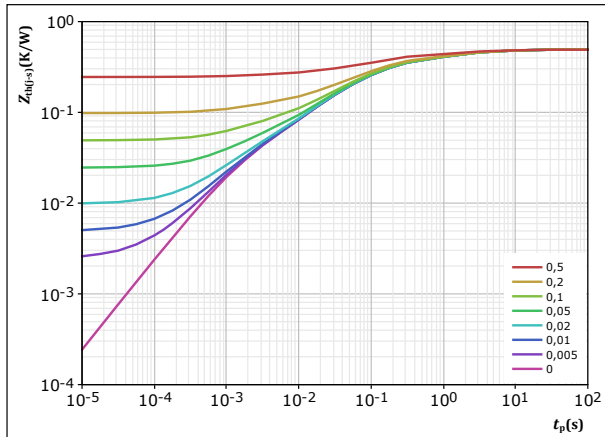
Boost Switch Characteristics

figure 11.

MOSFET

Transient thermal impedance as a function of pulse width

$$Z_{th(j-a)} = f(t_p)$$



$$D = \frac{t_p}{T}$$

$$R_{th(j-a)} = 0,491 \text{ K/W}$$

MOSFET thermal model values

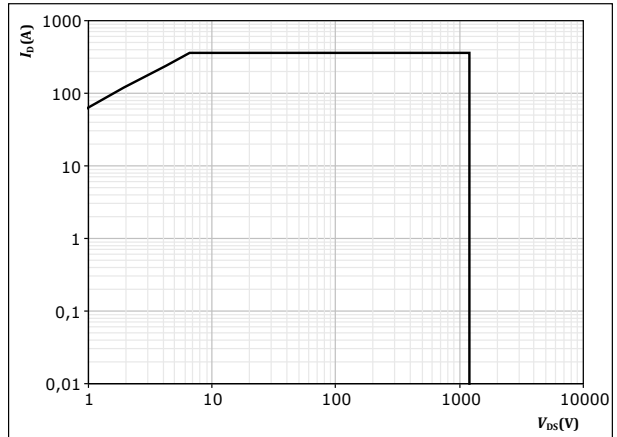
R (K/W)	τ (s)
4,84E-02	6,00E+00
1,15E-01	9,56E-01
2,27E-01	9,87E-02
7,54E-02	1,62E-02
2,51E-02	1,45E-03

figure 12.

MOSFET

Safe operating area

$$I_D = f(V_{DS})$$



D = single pulse

$$T_j = 80 \text{ } ^\circ\text{C}$$

$$V_{GS} = 15 \text{ V}$$

$$T_j = T_{jmax}$$



Vincotech

10-EY12NMA011ME30-LS28F18T
datasheet

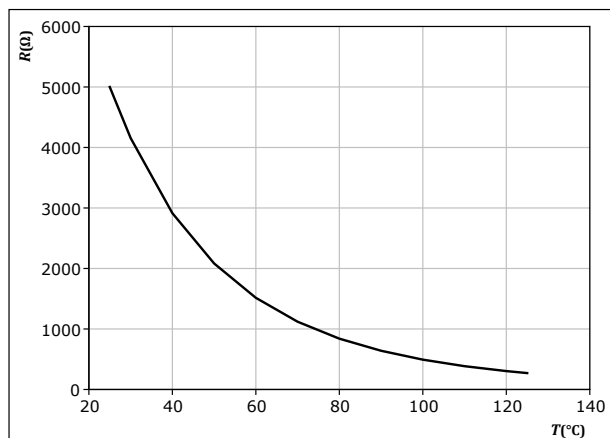
Thermistor Characteristics

figure 13.

Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$





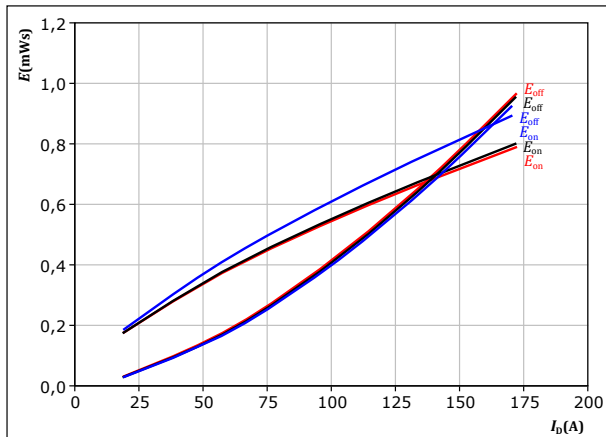
Vincotech

10-EY12NMA011ME30-LS28F18T datasheet

Buck Switching Characteristics

figure 14. MOSFET

Typical switching energy losses as a function of drain current
 $E = f(I_D)$



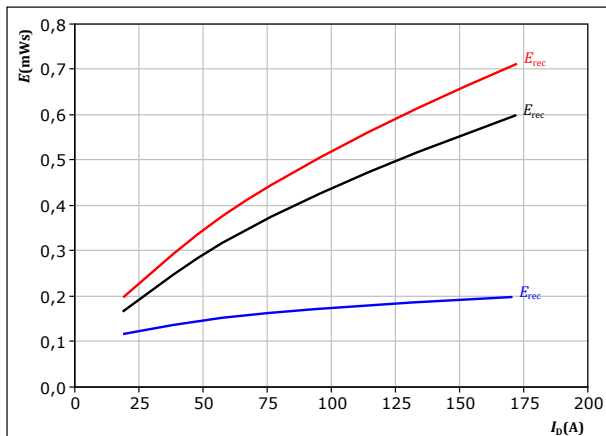
With an inductive load at

$V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω

T_j : 25 °C
125 °C
150 °C

figure 16. MOSFET

Typical reverse recovered energy loss as a function of drain current
 $E_{rec} = f(I_D)$



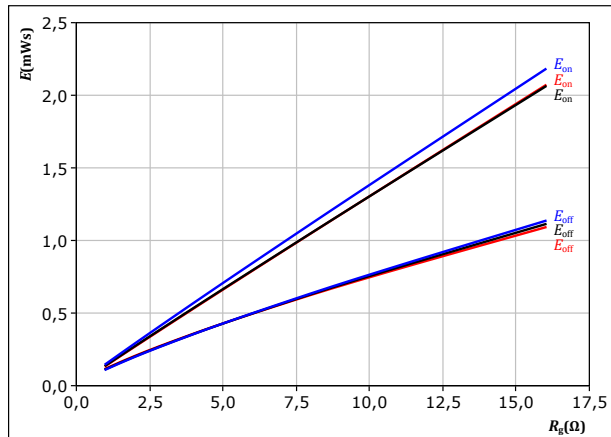
With an inductive load at

$V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $R_{gon} = 4$ Ω

T_j : 25 °C
125 °C
150 °C

figure 15. MOSFET

Typical switching energy losses as a function of MOSFET turn on gate resistor
 $E = f(R_g)$



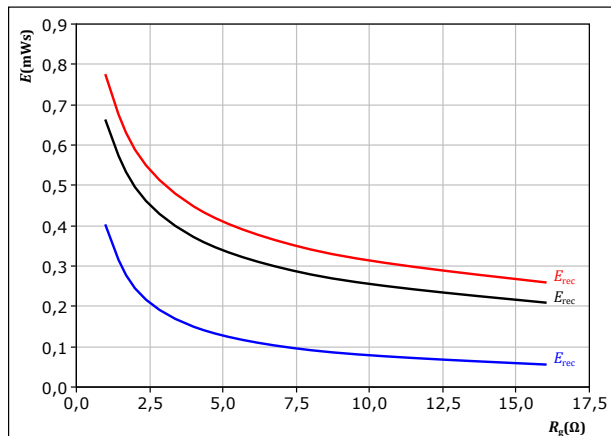
With an inductive load at

$V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $I_D = 95$ A

T_j : 25 °C
125 °C
150 °C

figure 17. MOSFET

Typical reverse recovered energy loss as a function of MOSFET turn on gate resistor
 $E_{rec} = f(R_g)$



With an inductive load at

$V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $I_D = 95$ A

T_j : 25 °C
125 °C
150 °C



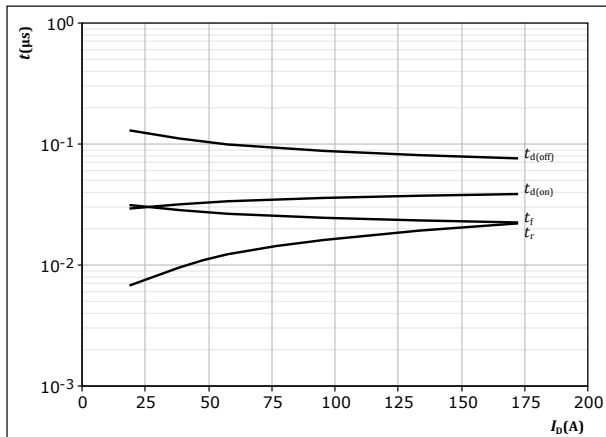
Vincotech

10-EY12NMA011ME30-LS28F18T datasheet

Buck Switching Characteristics

figure 18. MOSFET

Typical switching times as a function of drain current
 $t = f(I_D)$

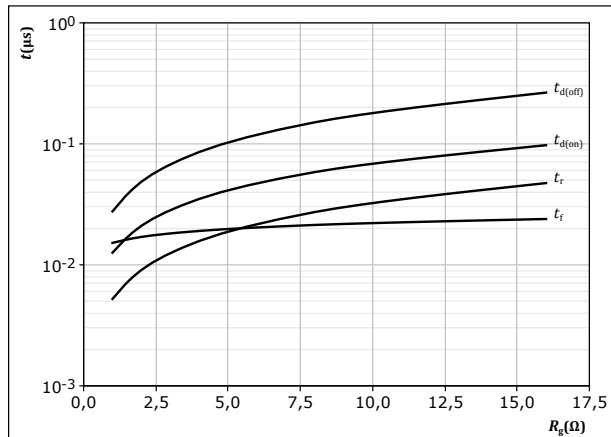


With an inductive load at

$T_j = 150$ °C
 $V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω

figure 19. MOSFET

Typical switching times as a function of MOSFET turn on gate resistor
 $t = f(R_g)$

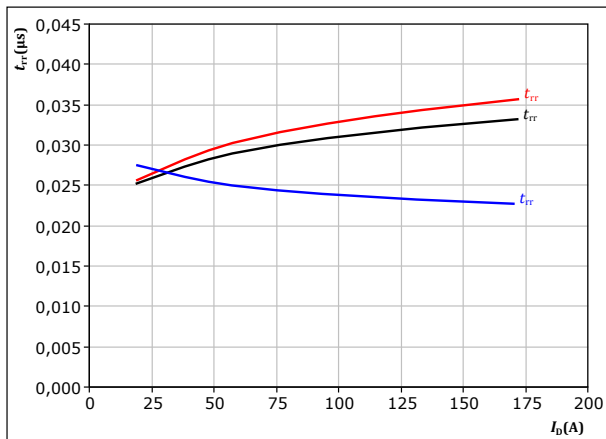


With an inductive load at

$T_j = 150$ °C
 $V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $I_D = 95$ A

figure 20. MOSFET

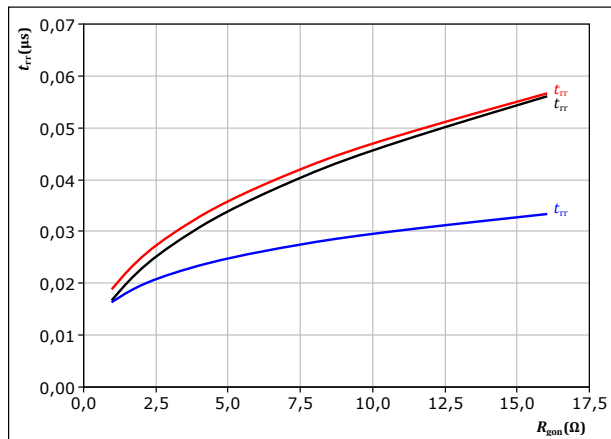
Typical reverse recovery time as a function of drain current
 $t_{rr} = f(I_D)$



At $V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $R_{gon} = 4$ Ω
 $T_j: 25$ °C (blue)
 125 °C (black)
 150 °C (red)

figure 21. MOSFET

Typical reverse recovery time as a function of MOSFET turn on gate resistor
 $t_{rr} = f(R_{gon})$



At $V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $I_D = 95$ A
 $T_j: 25$ °C (blue)
 125 °C (black)
 150 °C (red)



Vincotech

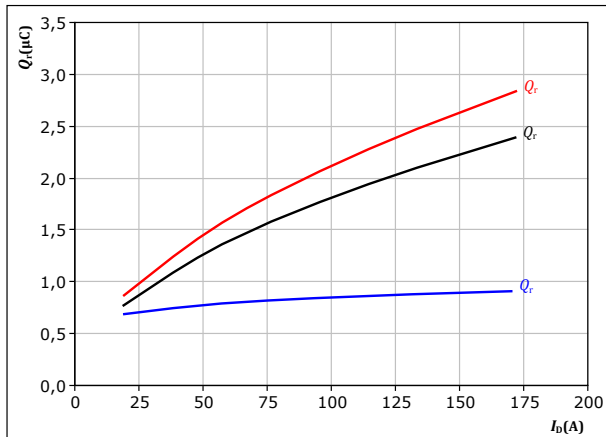
Buck Switching Characteristics

figure 22.

MOSFET

Typical recovered charge as a function of drain current

$$Q_r = f(I_D)$$



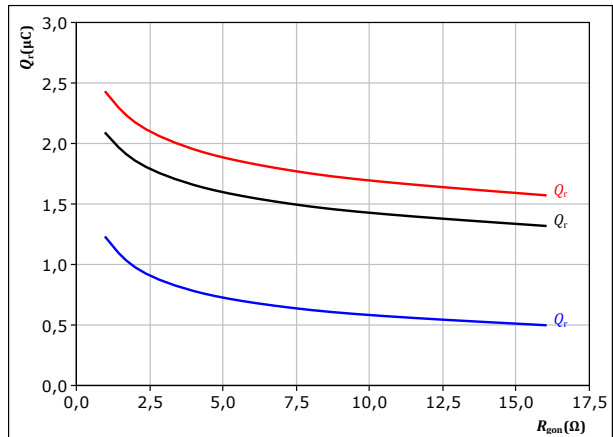
At $V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $R_{gon} = 4$ Ω
 T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 23.

MOSFET

Typical recovered charge as a function of MOSFET turn on gate resistor

$$Q_r = f(R_{gon})$$



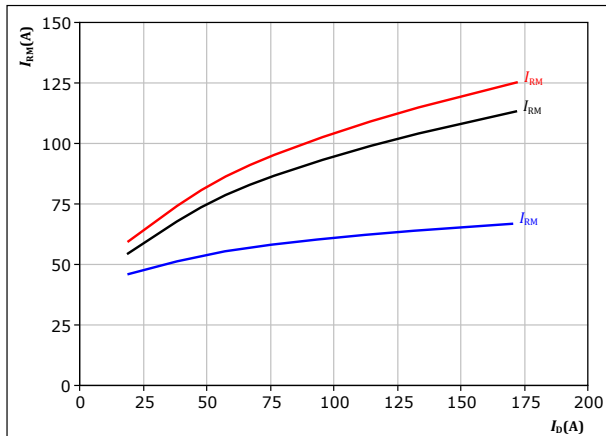
At $V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $I_D = 95$ A
 T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 24.

MOSFET

Typical peak reverse recovery current as a function of drain current

$$I_{RM} = f(I_D)$$



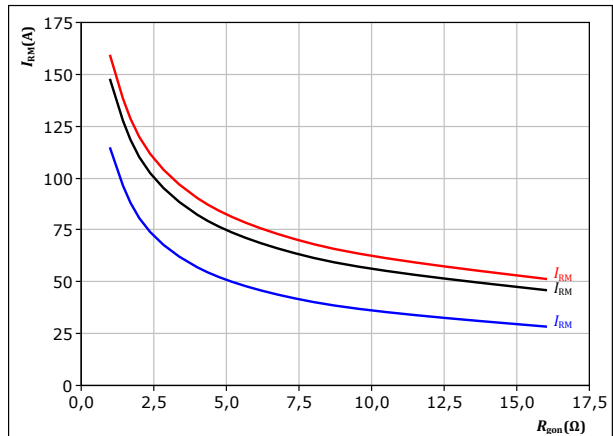
At $V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $R_{gon} = 4$ Ω
 T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 25.

MOSFET

Typical peak reverse recovery current as a function of MOSFET turn on gate resistor

$$I_{RM} = f(R_{gon})$$



At $V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $I_D = 95$ A
 T_j : 25 °C (blue), 125 °C (black), 150 °C (red)



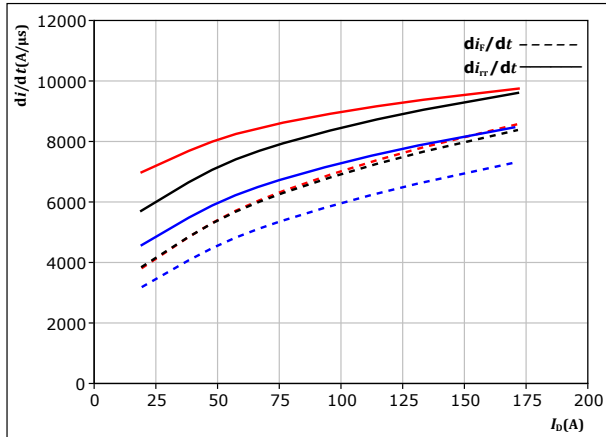
Vincotech

10-EY12NMA011ME30-LS28F18T datasheet

Buck Switching Characteristics

figure 26. MOSFET

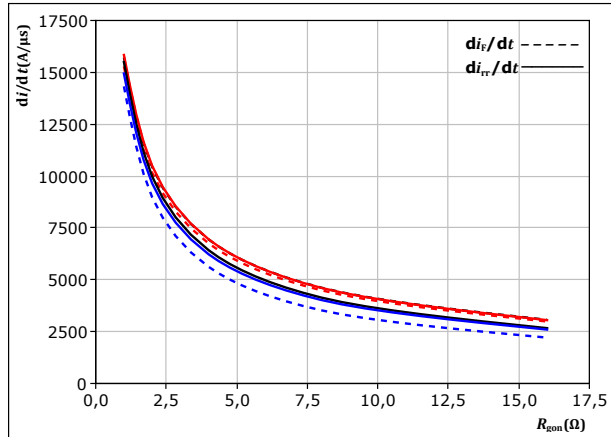
Typical rate of fall of forward and reverse recovery current as a function of drain current
 $di_f/dt, di_r/dt = f(I_D)$



At $V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $R_{gon} = 4$ Ω
 $T_j = 25$ °C
125 °C
150 °C

figure 27. MOSFET

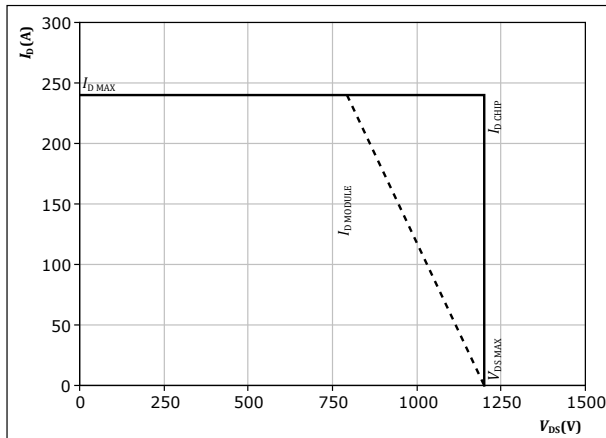
Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_r/dt = f(R_{gon})$



At $V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $I_D = 95$ A
 $T_j = 25$ °C
125 °C
150 °C

figure 28. MOSFET

Reverse bias safe operating area
 $I_D = f(V_{DS})$



At $T_j = 150$ °C
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω



Vincotech

10-EY12NMA011ME30-LS28F18T datasheet

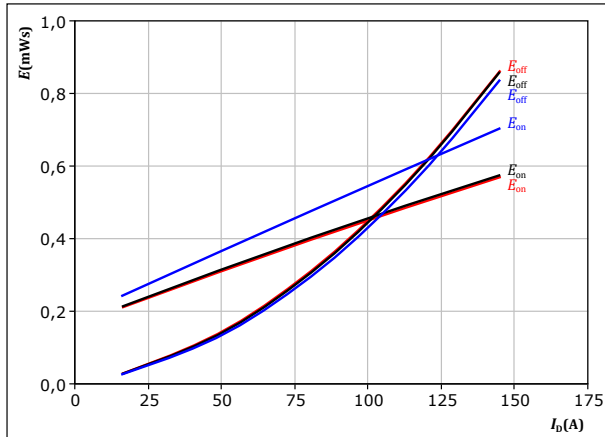
Boost Switching Characteristics

figure 29.

MOSFET

Typical switching energy losses as a function of drain current

$$E = f(I_D)$$



With an inductive load at

$V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω

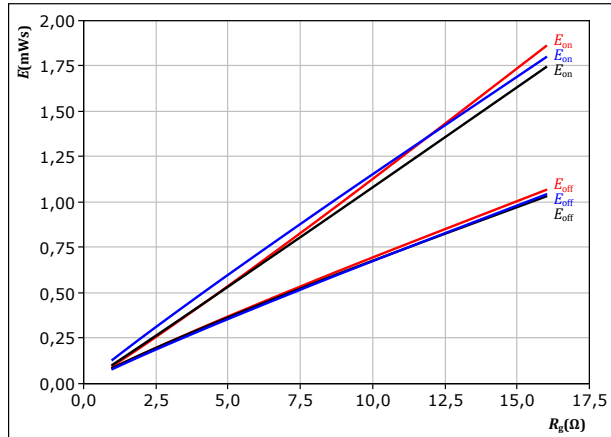
T_j : 25 °C
125 °C
150 °C

figure 30.

MOSFET

Typical switching energy losses as a function of MOSFET turn on gate resistor

$$E = f(R_g)$$



With an inductive load at

$V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $I_D = 80$ A

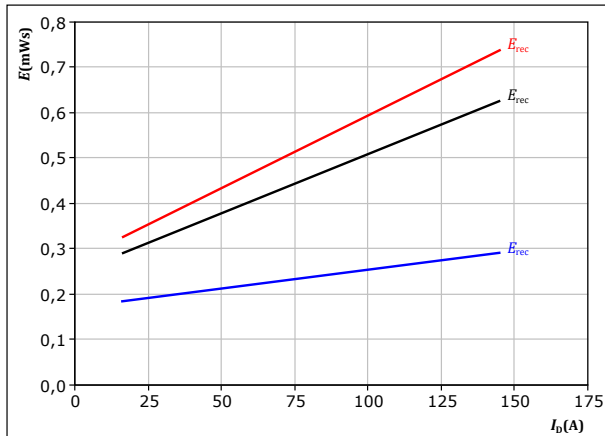
T_j : 25 °C
125 °C
150 °C

figure 31.

MOSFET

Typical reverse recovered energy loss as a function of drain current

$$E_{rec} = f(I_D)$$



With an inductive load at

$V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $R_{gon} = 4$ Ω

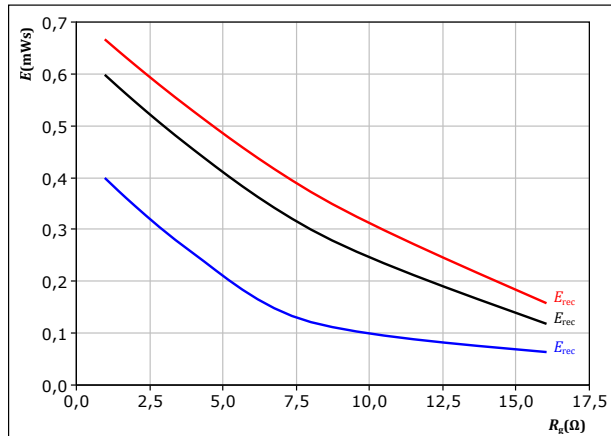
T_j : 25 °C
125 °C
150 °C

figure 32.

MOSFET

Typical reverse recovered energy loss as a function of MOSFET turn on gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $I_D = 80$ A

T_j : 25 °C
125 °C
150 °C



Vincotech

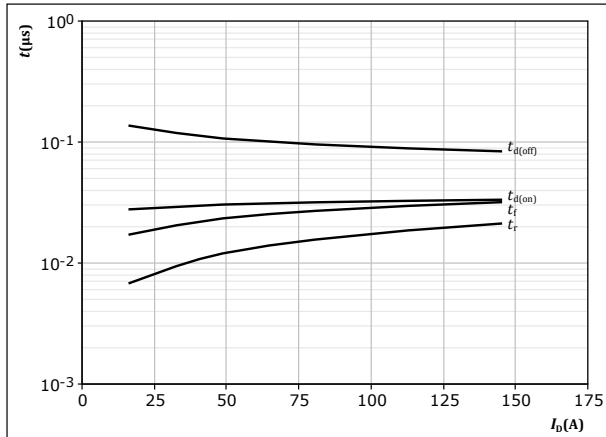
10-EY12NMA011ME30-LS28F18T

datasheet

Boost Switching Characteristics

figure 33. MOSFET

Typical switching times as a function of drain current
 $t = f(I_D)$

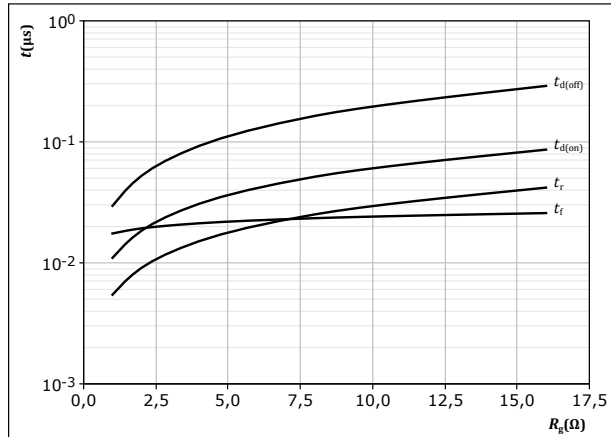


With an inductive load at

$T_j = 150$ °C
 $V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω

figure 34. MOSFET

Typical switching times as a function of MOSFET turn on gate resistor
 $t = f(R_g)$

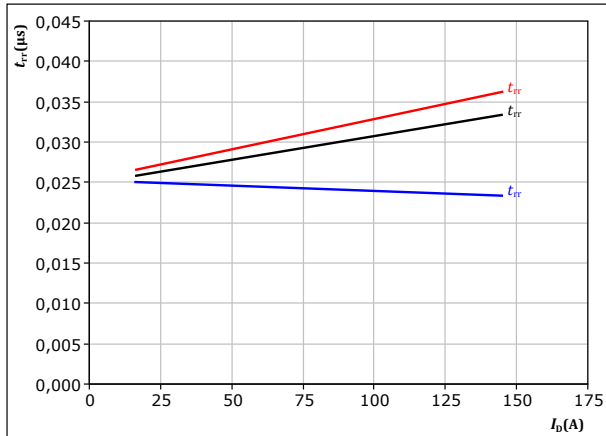


With an inductive load at

$T_j = 150$ °C
 $V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $I_D = 80$ A

figure 35. MOSFET

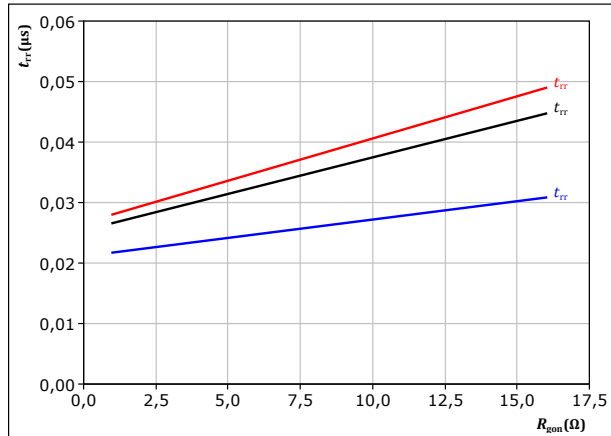
Typical reverse recovery time as a function of drain current
 $t_{rr} = f(I_D)$



At $V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $R_{gon} = 4$ Ω
 $T_j: 25$ °C (blue)
 125 °C (black)
 150 °C (red)

figure 36. MOSFET

Typical reverse recovery time as a function of MOSFET turn on gate resistor
 $t_{rr} = f(R_{gon})$



At $V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $I_D = 80$ A
 $T_j: 25$ °C (blue)
 125 °C (black)
 150 °C (red)



Vincotech

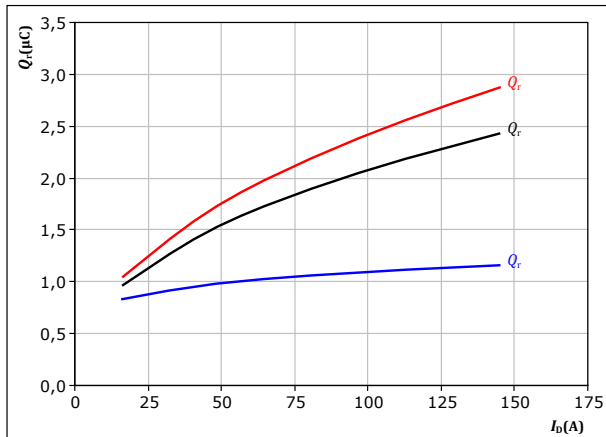
10-EY12NMA011ME30-LS28F18T datasheet

Boost Switching Characteristics

figure 37. MOSFET

Typical recovered charge as a function of drain current

$$Q_r = f(I_D)$$

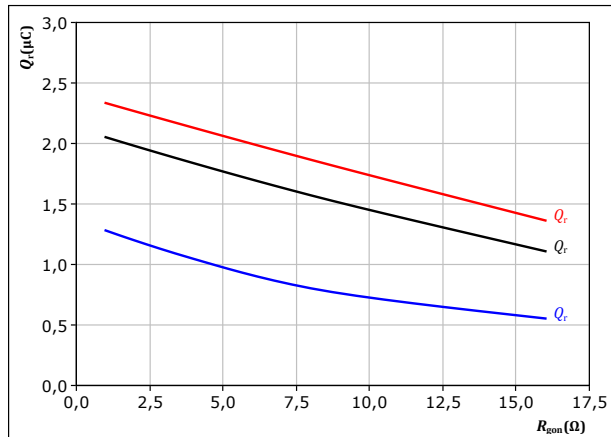


At $V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $R_{gon} = 4$ Ω
 T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 38. MOSFET

Typical recovered charge as a function of MOSFET turn on gate resistor

$$Q_r = f(R_{gon})$$

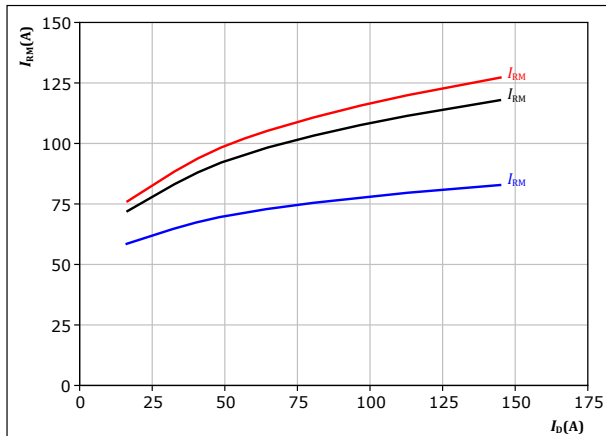


At $V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $I_D = 80$ A
 T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 39. MOSFET

Typical peak reverse recovery current as a function of drain current

$$I_{RM} = f(I_D)$$

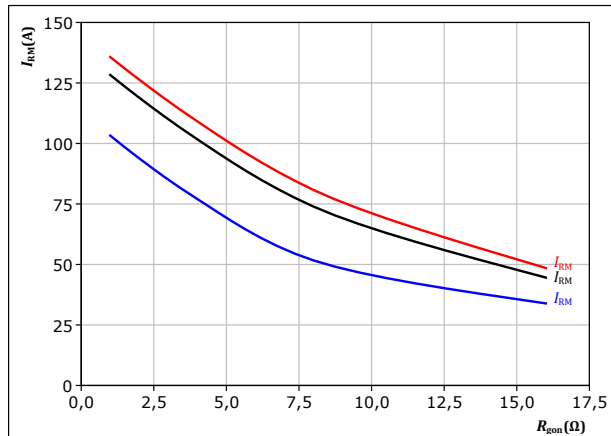


At $V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $R_{gon} = 4$ Ω
 T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 40. MOSFET

Typical peak reverse recovery current as a function of MOSFET turn on gate resistor

$$I_{RM} = f(R_{gon})$$



At $V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $I_D = 80$ A
 T_j : 25 °C (blue), 125 °C (black), 150 °C (red)



Vincotech

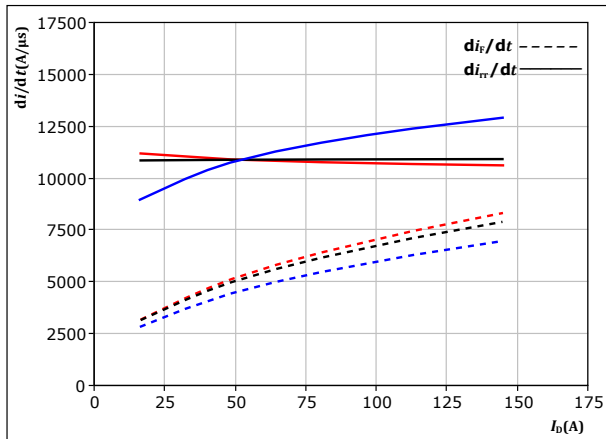
10-EY12NMA011ME30-LS28F18T

datasheet

Boost Switching Characteristics

figure 41. MOSFET

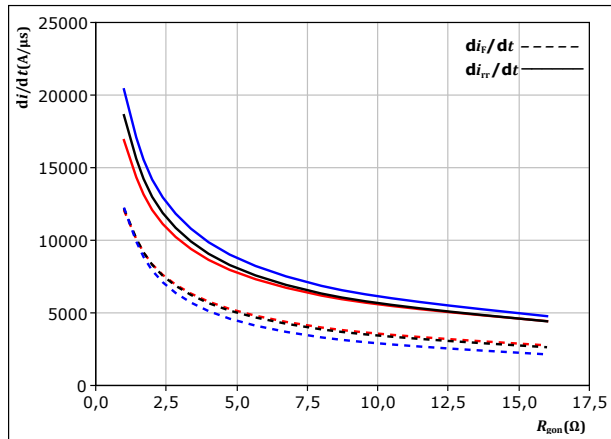
Typical rate of fall of forward and reverse recovery current as a function of drain current
 $di_f/dt, di_r/dt = f(I_D)$



At $V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $R_{gon} = 4$ Ω
 $T_j = 25$ °C
 $T_j = 125$ °C
 $T_j = 150$ °C

figure 42. MOSFET

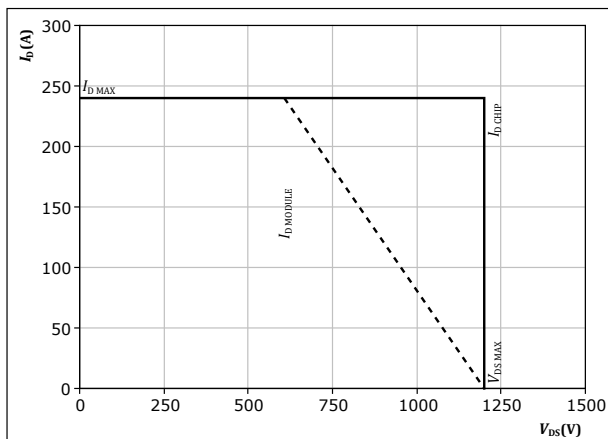
Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_r/dt = f(R_{gon})$



At $V_{DS} = 350$ V
 $V_{GS} = -4/15$ V
 $I_D = 80$ A
 $T_j = 25$ °C
 $T_j = 125$ °C
 $T_j = 150$ °C

figure 43. MOSFET

Reverse bias safe operating area
 $I_D = f(V_{DS})$



At $T_j = 150$ °C
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω



Vincotech

10-EY12NMA011ME30-LS28F18T datasheet

Switching Definitions

figure 44. MOSFET

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

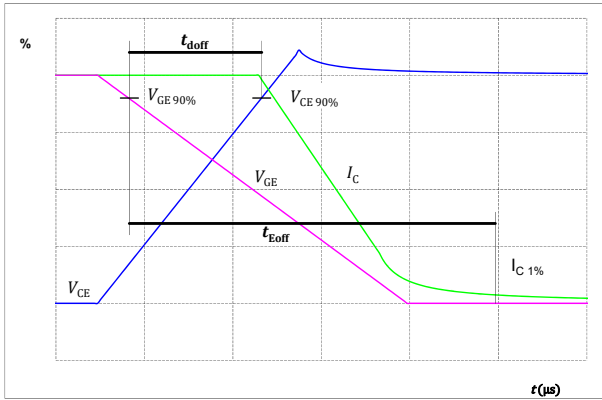


figure 45. MOSFET

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

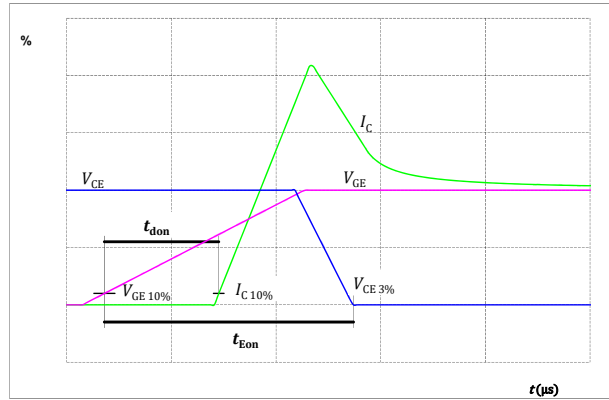


figure 46. MOSFET

Turn-off Switching Waveforms & definition of t_f

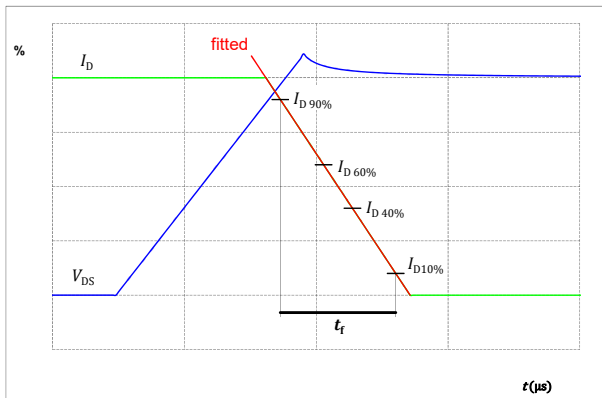
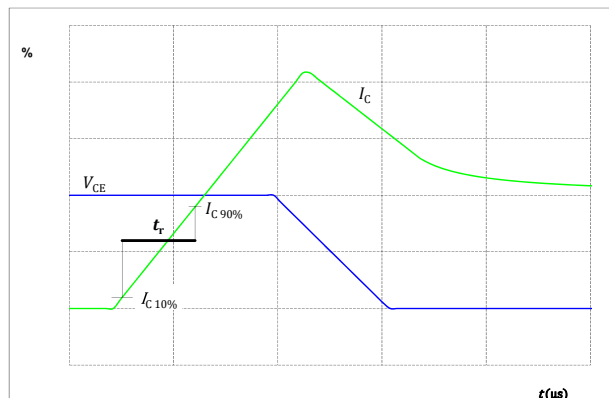


figure 47. MOSFET

Turn-on Switching Waveforms & definition of t_r





Vincotech

Switching Definitions

figure 48.

FWD

Turn-off Switching Waveforms & definition of t_{rr}

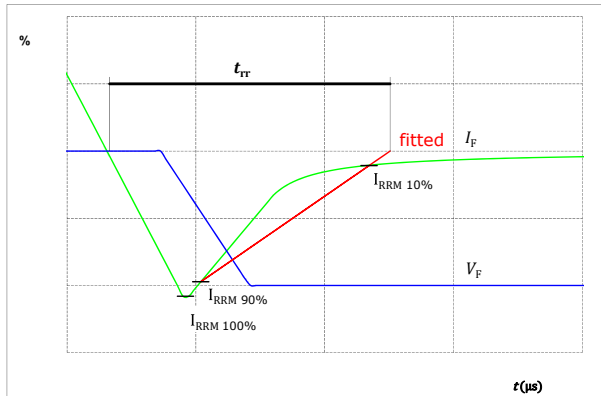


figure 49.

FWD

Turn-on Switching Waveforms & definition of t_{Qrr} (t_{Qrr} = integrating time for Q_{rr})

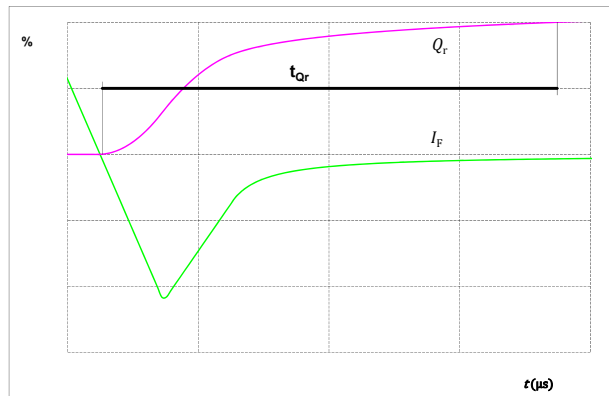
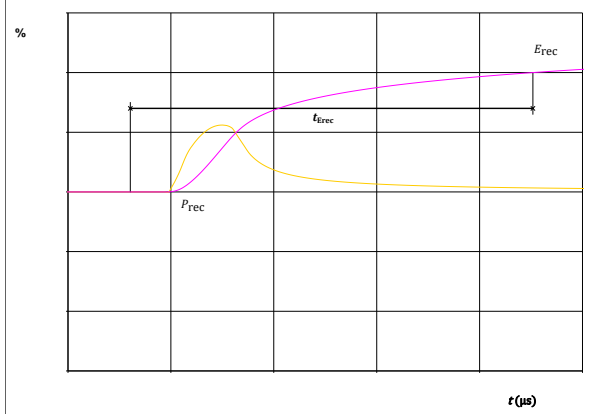


figure 50.

FWD


Turn-on Switching Waveforms & definition of t_{Erec} (t_{Erec} = integrating time for E_{rec})





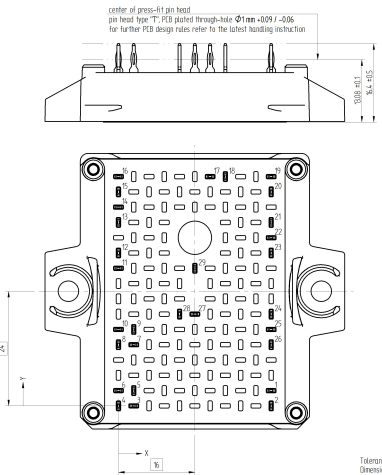
10-EY12NMA011ME30-LS28F18T
datasheet

Ordering Code	
Version	Ordering Code
Without thermal paste	10-EY12NMA011ME30-LS28F18T
With thermal paste (5.2 W/mK, PTM6000HV)	10-EY12NMA011ME30-LS28F18T-/7/

Marking							
	Text	Name		Date code	UL & VIN	Lot	Serial
		NN-NNNNNNNNNNNNNN- TTTTTV		WWYY	UL VIN	LLLLL	SSSS
	Datamatrix	Type&Ver	Lot number	Serial	Date code		
		TTTTTV	LLLLL	SSSS	WWYY		

Outline
Pin table [mm]

Pin	X	Y	Function
1	32	3,2	S11
2	32	0	G11
3	3,2	0	DC+
4	0	0	DC+
5	3,2	3,2	DC+
6	0	3,2	DC+
7	3,2	12,8	GND
8	0	12,8	GND
9	3,2	16	GND
10	0	16	GND
11	0	28,8	S14
12	0	32	G14
13	0	38,4	DC-
14	0	41,6	DC-
15	0	44,8	DC-
16	0	48	DC-
17	19,2	48	S12
18	22,4	48	G12
19	32	48	Therm1
20	32	44,8	Therm2
21	32	38,4	Ph
22	32	35,2	Ph
23	32	32	Ph
24	32	19,2	Ph
25	32	16	Ph
26	32	12,8	Ph
27	16	19,2	S13
28	12,8	19,2	G13
29	16	28,8	CC



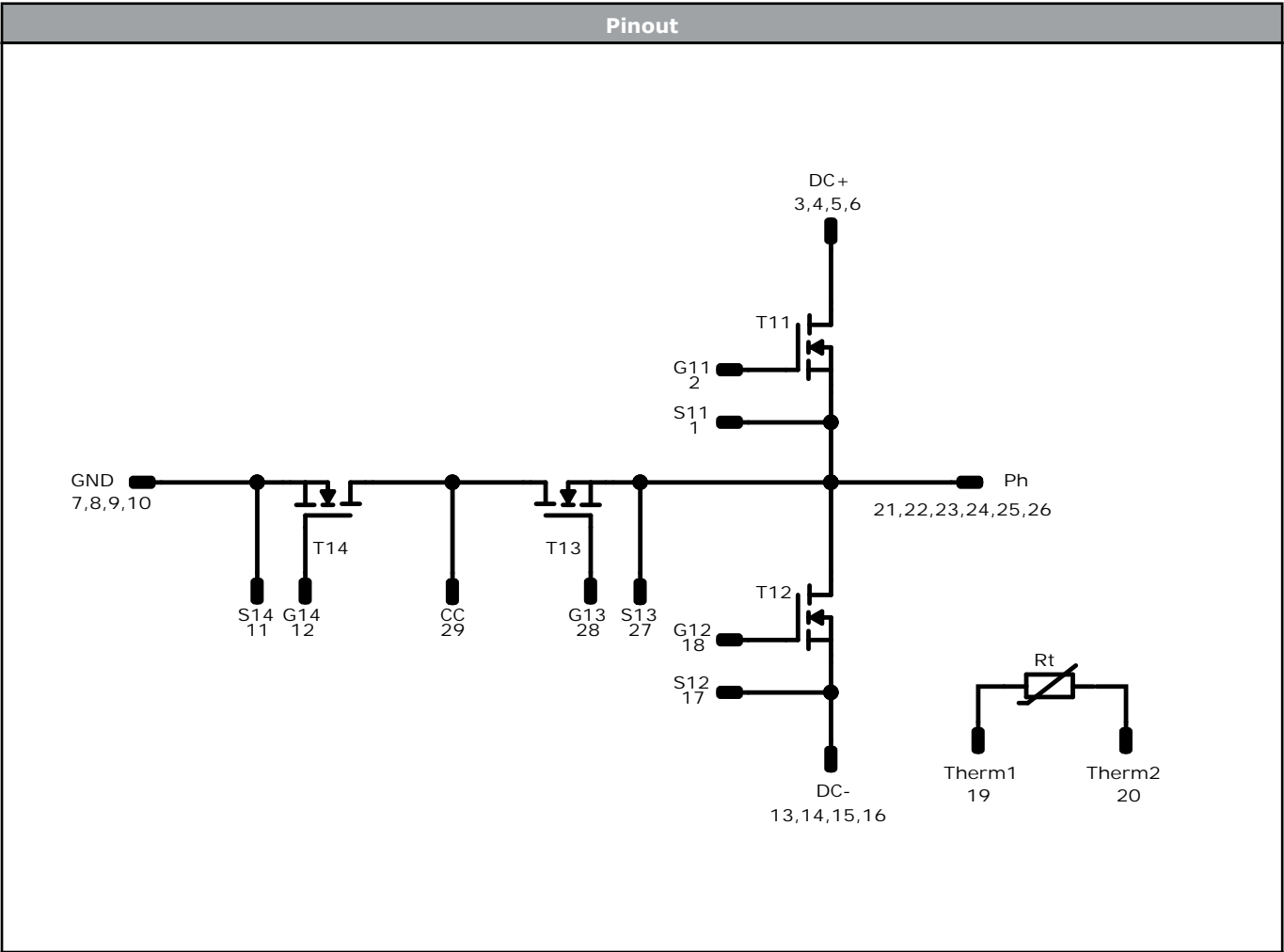
Tolerance of positions: ±0.05 mm at the end of pin

Dimension of coordinate axis is only offset without tolerance



Vincotech

10-EY12NMA011ME30-LS28F18T
datasheet



Identification					
ID	Component	Voltage	Current	Function	Comment
T11, T12	MOSFET	1200 V	10,67 mΩ	Buck Switch	
T13, T14	MOSFET	1200 V	10,67 mΩ	Boost Switch	
Rt	Thermistor			Thermistor	



Vincotech

10-EY12NMA011ME30-LS28F18T
datasheet

Packaging instruction				
Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for <i>flow</i> E2 packages see vincotech.com website.

Package data
Package data for <i>flow</i> E2 packages see vincotech.com website.

Vincotech thermistor reference
See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number
This device is UL 1557 recognized under E192116 up to a junction temperature under switching condition $T_{j,op}=175^{\circ}\text{C}$ and up to 3500VAC/1min isolation voltage. For more information see vincotech.com website.



Document No.:	Date:	Modification:	Pages
10-EY12NMA011ME30-LS28F18T-D2-14	11 May. 2025	Update Dynamic characteristics using the same conditions. Module is unchanged.	

DISCLAIMER

The information, specifications, procedures, methods and recommendations herein (together "information") are presented by Vincotech to reader in good faith, are believed to be accurate and reliable, but may well be incomplete and/or not applicable to all conditions or situations that may exist or occur. Vincotech reserves the right to make any changes without further notice to any products to improve reliability, function or design. No representation, guarantee or warranty is made to reader as to the accuracy, reliability or completeness of said information or that the application or use of any of the same will avoid hazards, accidents, losses, damages or injury of any kind to persons or property or that the same will not infringe third parties rights or give desired results. It is reader's sole responsibility to test and determine the suitability of the information and the product for reader's intended use.

LIFE SUPPORT POLICY

Vincotech products are not authorised for use as critical components in life support devices or systems without the express written approval of Vincotech.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.